

DO NOT SCALE FROM THIS PRINT

No. OF POS	"C"
-019	.950 [24.13]
-038	1.450 [36.83]
-057	1.950 [49.53]
-076	2.450 [62.23]
-095	2.950 [74.93]
-114	3.450 [87.63]
-133	3.950 [100.33]

No OF POSITIONS	COPLANARITY
-019, -038, -057, -076	.004[0.10]
-095, -114, -133	.006[0.15]

MIT-XXX-XX-X-D-XX

No OF POSITIONS
 -019, -038, -057, -076,
 **-.095, **-.114, **-.133
 (PER ROW)
 (** = SEE NOTE 11)

LEAD STYLE
 -01: .1680[4.267]
 -02: .2861[7.267]
 -03: .4042[10.267]
 -04: .6000[15.240]
 -05: .7080[17.983]
 -06: .8350[21.209]

OPTION
 -K: POLYAMIDE FILM PAD
 (USE K-DOT-.276-.375-.005, SEE FIG 3, SHT 2)
 -TR: TAPE & REEL (076 POS MAX)
 (N/A ON STYLE -05, -06, -07 & -08)

ROW SPECIFICATION
 -D: DOUBLE (USE MIT-19-XX-D-XX
 & MITH-19-XX-D-XX)

No OF BANKS

PLATING SPECIFICATION
 -F: 3μ" FLASH SELECTIVE GOLD IN CONTACT AREA,
 MATTE TIN ON TAIL
 (USE T-1SXX-XX-F & T-1G5-XX-F) (SEE NOTE 10)
 -L: 10μ" LIGHT SELECTIVE GOLD IN CONTACT AREA,
 MATTE TIN ON TAIL
 (USE T-1SXX-XX-L & T-1G5-XX-L)
 -H: 30μ" HEAVY GOLD IN CONTACT AREA, 3μ" GOLD ON TAIL
 (USE T-1SXX-XX-H & T-1G5-XX-L)
 -C: 50μ" ELECTRO-POLISHED SELECTIVE GOLD IN CONTACT AREA,
 MATTE TIN ON TAIL (USE T-1SXX-XX-C & T-1G5-XX-L)

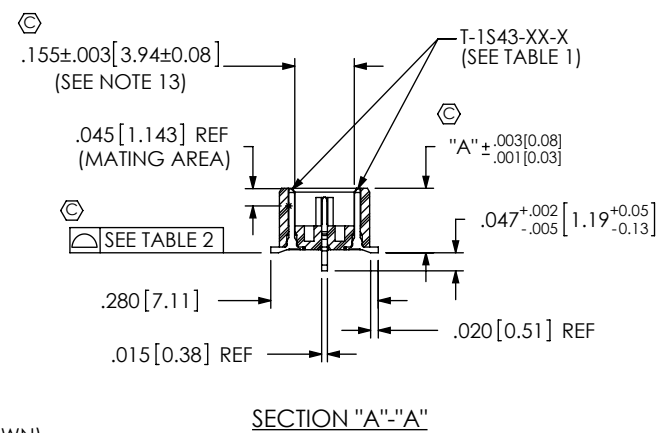
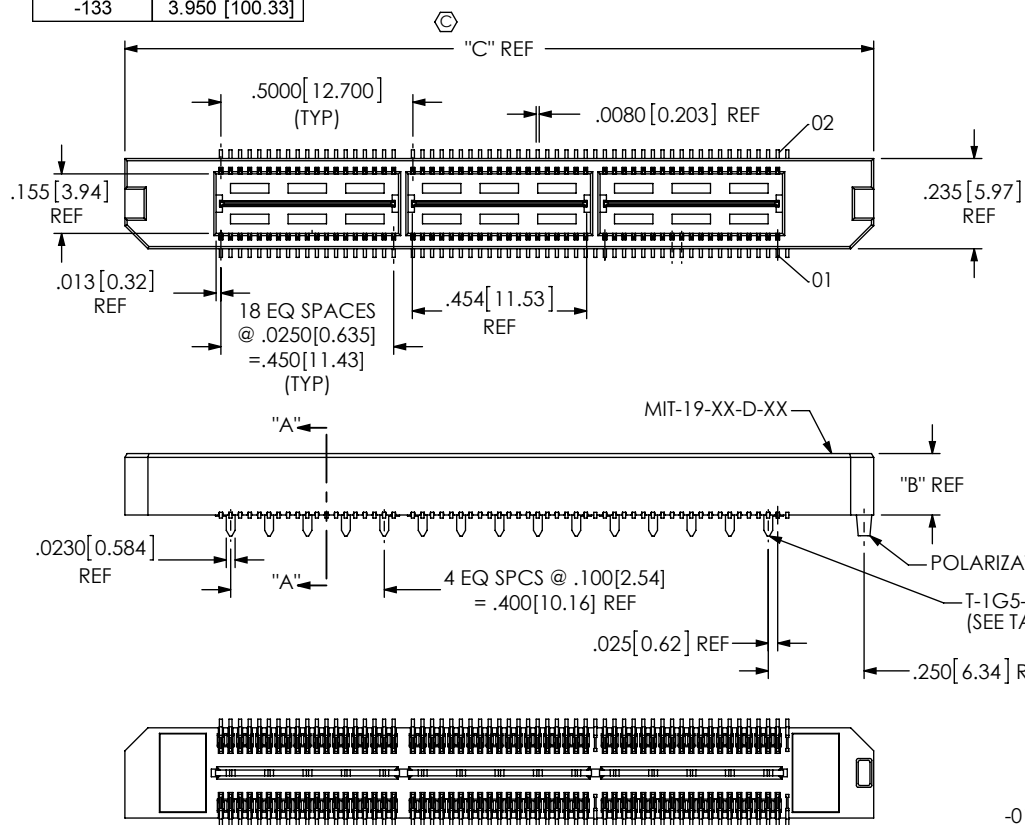


FIG 1
 -01 LEAD STYLE
 (MIT-057-01-X-D SHOWN)
 (STYLE -01 & -02 ONLY)

STYLE	"A"	"B"	"D"	BODY	TERMINAL	GROUND PLANE	SPACER	MATED HEIGHT WITH MIS-01
-01	.1680[4.267]	.1600[4.064]	N/A	MIT-19-01-D-XX	T-1S43-01-X	T-1G5-01-X	N/A	.198[5.03] REF
-02	.2861[7.267]	.2781[7.064]	N/A	MIT-19-02-D-XX	T-1S43-02-X	T-1G5-02-X	N/A	.316[8.03] REF
-03	.4042[10.267]	.3962[10.063]	0.1180[2.997]	MIT-19-02-D-XX	T-1S50-03-X	T-1G5-03-X	MITH-19-01-D-XX	.434[11.02] REF
-04	.6000[15.240]	.5920[15.037]	0.1180[2.997]	MIT-19-02-D-XX	T-1S50-04-X	T-1G5-04-X	MITH-19-01-D-XX	.630[16.00] REF
-05	.7080[17.983]	.7000[17.780]	0.2780[7.061]	MIT-19-02-D-XX	T-1S50-05-X	T-1G5-05-X	MITH-19-02-D-XX	.738[18.75] REF
-06	.8350[21.209]	.8270[21.006]	0.2780[7.061]	MIT-19-02-D-XX	T-1S50-06-X	T-1G5-06-X	MITH-19-02-D-XX	.866[22.00] REF

- NOTES:
1. Ⓢ REPRESENTS A CRITICAL DIMENSION.
 2. COPLANARITY: SEE TABLE 2.
 3. MAXIMUM BURR ALLOWANCE: .0015[0.038] .
 4. MINIMUM TERMINAL RETENTION: 8 OZ.
 5. MINIMUM GROUND PLANE RETENTION: 1 LB.
 6. MAXIMUM ALLOWABLE BOW: .002[0.05] INCH/INCH AFTER ASSEMBLY.
 7. PARTS TO BE MOLDED TO POSITION.
 8. NOTE DELETED.
 9. NOTE DELETED.
 10. -L PLATING CAN BE SUBSTITUTED FOR -F PLATING,
 -L PLATED GROUND PLANE CAN BE SUBSTITUTED FOR -F PLATED GROUND PLANE.
 11. APPLICATIONS REQUIRING THESE POSITIONS, PLEASE CONTACT
 SAMTEC INTERCONNECT PROCESSING GROUP.
 12. PARTS TO BE PACKAGED IN TRAYS.
 13. PIN CAN EXTEND PAST WALL .003[0.08] MAX.

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES.
 TOLERANCES ARE:
 DECIMALS ANGLES
 .XX: ±.01[.3] ± 2°
 .XXX: ±.005[.13]
 .XXXX: ±.0020[.051]

PROPRIETARY NOTE
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MATERIAL: DO NOT SCALE DRAWING SHEET SCALE: 2:1
 INSULATOR: LCP, UL94V-0; COLOR: BLACK
 TERMINAL: PHOS BRONZE
 GROUND PLANE: PHOS BRONZE

F:\DWG\MISC\MKTG\MIT-XXX-XX-X-D-XX-MKT.SLDDRW

samtec
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DESCRIPTION:
 .635mm DOUBLE ROW HS TERMINAL ASSEMBLY

DWG. NO.
MIT-XXX-XX-X-D-XX

BY: DEAN P 7/7/1999 SHEET 1 OF 2

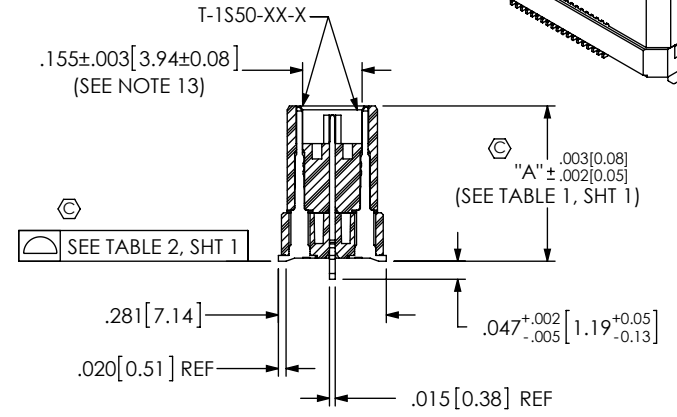
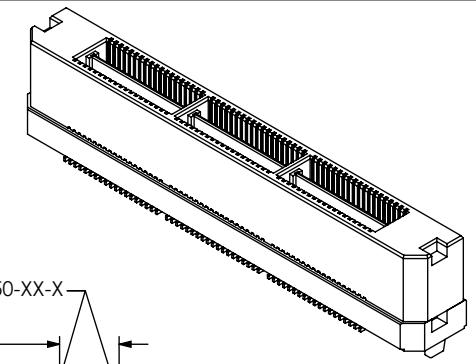
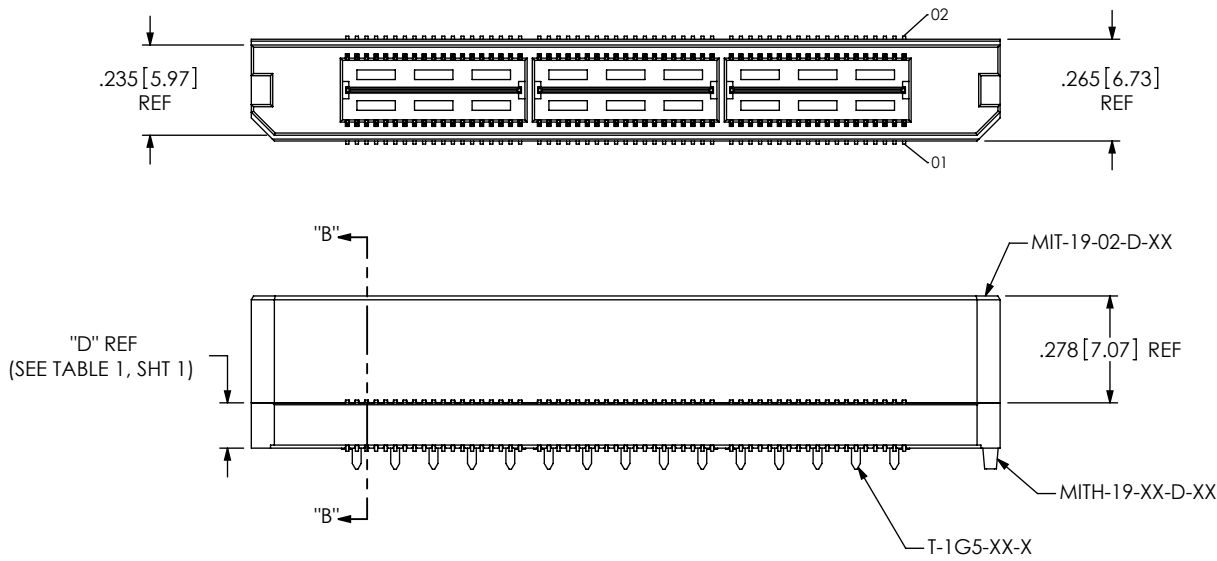


FIG 2
-03 LEAD STYLE
(MIT-057-03-X-D SHOWN)
(DIFFERENT AS SHOWN, OTHERWISE SAME AS FIG 1)
(STYLE -03, -04, -05, & -06)

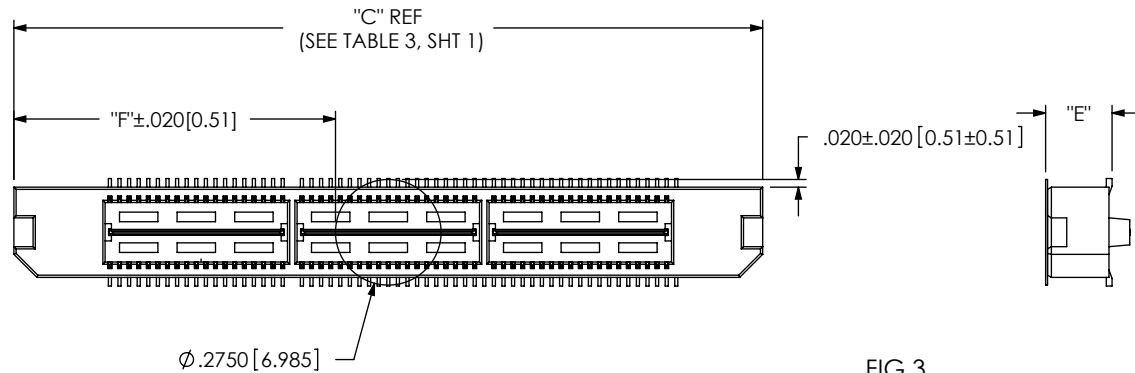


FIG 3
-K: POLYAMIDE FILM PAD OPTION

TABLE 4	
STYLE	"E"
-01	.173 [4.39]
-02	.291 [7.39]
-03	.409 [10.39]
-04	.605 [15.37]
-05	.713 [18.11]
-06	.841 [21.36]

TABLE 5	
No. OF POS	"F"
-019	.338 [8.57]
-038	.588 [14.92]
-057	.838 [21.27]
-076	1.088 [27.62]
-095	1.338 [33.97]
-114	1.588 [40.32]
-133	1.838 [46.67]

CRITICAL DIMENSION INSPECTION INSTRUCTION TABLE

ASSEMBLY OPERATION	IN PROCESS INSPECTION
FILL T-1SXX	C1, C2, C3, C4, C5, C6
ADD -K OPTION	C7, C8

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DO NOT SCALE DRAWING
SHEET SCALE: 2:1



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.635mm DOUBLE ROW HS TERMINAL ASSEMBLY

DWG. NO. MIT-XXX-XX-X-D-XX

BY: DEAN P 7/7/1999 SHEET 2 OF 2